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Kind regards,

Team Nexperia



# PBSS2540E 40 V, 500 mA NPN low V<sub>CEsat</sub> (BISS) transistor Rev. 02 — 15 November 2009

Product data sheet

#### **Product profile** 1.

#### 1.1 General description

NPN low V<sub>CEsat</sub> Breakthrough in Small Signal (BISS) transistor in a SOT416 (SC-75) SMD plastic package.

PNP complement: PBS3540E.

#### **1.2 Features**

- Low collector-emitter saturation voltage V<sub>CEsat</sub>
- High collector current capability: I<sub>C</sub> and I<sub>CM</sub>
- High collector current gain (h<sub>FE</sub>) at high I<sub>C</sub>
- High efficiency due to less heat generation
- Smaller required Printed-Circuit Board (PCB) area than for conventional transistors

### 1.3 Applications

- DC-to-DC conversion
- MOSFET gate driving
- Motor control
- Charging circuits
- Low power switches (e.g. motors, fans)

#### 1.4 Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CEO}$	collector-emitter voltage	open base	-	-	40	V
I <sub>C</sub>	collector current (DC)		-	-	500	mA
I <sub>CM</sub>	peak collector current		-	-	1	А
R <sub>CEsat</sub>	collector-emitter saturation resistance	I <sub>C</sub> = 500 mA; I <sub>B</sub> = 50 mA	<u>[1]</u> _	380	500	mΩ

[1] Pulse test:  $t_p \leq 300 \ \mu s$ ;  $\delta \leq 0.02$ 



40 V, 500 mA NPN low V<sub>CEsat</sub> (BISS) transistor

## 2. Pinning information

	Symbol	Simplified outline	Description	Pin
		-	base	1
3	3		emitter	2
	1	1 2	collector	3
/	svi			

## 3. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PBSS2540E	SC-75	plastic surface mounted package; 3 leads	SOT416			

## 4. Marking

Table 4. Marking codes	
Type number	Marking code
PBSS2540E	1S

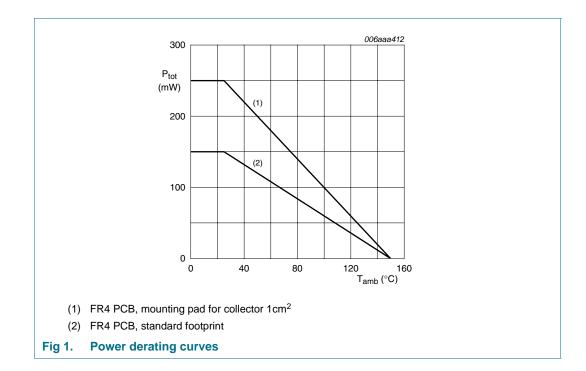
40 V, 500 mA NPN low V<sub>CEsat</sub> (BISS) transistor

## 5. Limiting values

Table 5. In accorda	Limiting values ince with the Absolute Maximi	um Rating System (I	EC 60134).		
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter	-	40	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	40	V
$V_{\text{EBO}}$	emitter-base voltage	open collector	-	6	V
I <sub>C</sub>	collector current (DC)		-	500	mA
I <sub>CM</sub>	peak collector current		-	1	А
I <sub>BM</sub>	peak base current		-	100	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> -	150	mW
			[2] _	250	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1cm<sup>2</sup>.



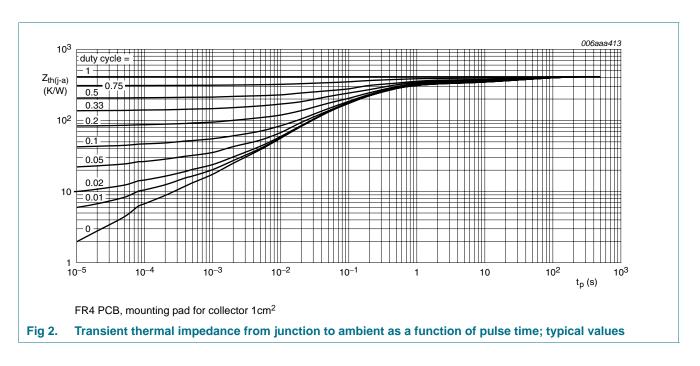
40 V, 500 mA NPN low V<sub>CEsat</sub> (BISS) transistor

## 6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from	in free air	<u>[1]</u> _	-	833	K/W
	junction to ambient		[2] _	-	500	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1cm<sup>2</sup>.



## PBSS2540E

40 V, 500 mA NPN low V<sub>CEsat</sub> (BISS) transistor

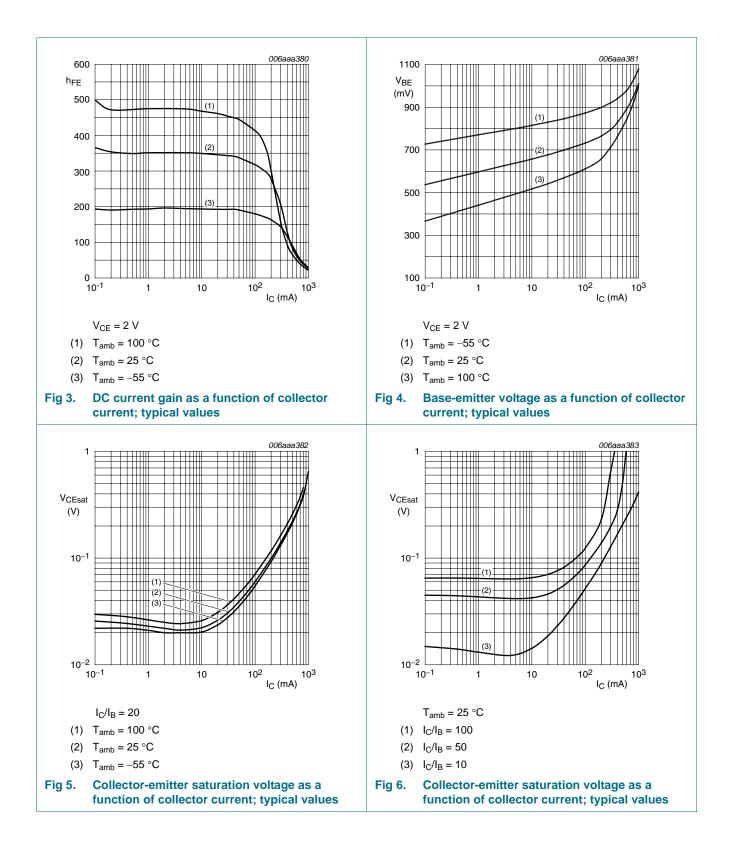
## 7. Characteristics

$I_{amb} = 25$	C unless otherwise speci	neu				
Symbol	Parameter	Conditions	Mir	n Typ	Max	Unit
I <sub>CBO</sub>	collector-base cut-off	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}$	-	-	100	nA
	current	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 \text{ °C}$	-	-	50	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 V; I_C = 0 A$	-	-	100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = 2 \text{ V}; I_{C} = 10 \text{ mA}$	200	) -	-	
		$V_{CE} = 2 \text{ V}; I_{C} = 100 \text{ mA}$	[ <u>1]</u> 100	) -	-	
		$V_{CE} = 2 \text{ V}; I_{C} = 500 \text{ mA}$	<u>[1]</u> 50	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$	-	-	50	mV
		$I_{C} = 100 \text{ mA}; I_{B} = 5 \text{ mA}$	-	-	100	mV
		$I_{C} = 200 \text{ mA}; I_{B} = 10 \text{ mA}$	-	-	200	mV
		$I_{C} = 500 \text{ mA}; I_{B} = 50 \text{ mA}$	<u>[1]</u> _	-	250	mV
R <sub>CEsat</sub>	collector-emitter saturation resistance	$I_{\rm C}$ = 500 mA; $I_{\rm B}$ = 50 mA	<u>[1]</u> _	380	500	mΩ
V <sub>BEsat</sub>	base-emitter saturation voltage	$I_{\rm C}$ = 500 mA; $I_{\rm B}$ = 50 mA	[1] -	-	1.2	V
V <sub>BEon</sub>	base-emitter turn-on voltage	$V_{CE} = 2 \text{ V}; I_{C} = 100 \text{ mA}$	-	-	1.1	V
f <sub>T</sub>	transition frequency	$V_{CE} = 5 \text{ V}; I_C = 100 \text{ mA};$ f = 100 MHz	250	) 450	-	MHz
C <sub>c</sub>	collector capacitance	V <sub>CB</sub> = 10 V; I <sub>E</sub> = i <sub>e</sub> = 0 A; f = 1 MHz	-	-	6	pF

[1] Pulse test:  $t_p \leq 300~\mu\text{s};~\delta \leq 0.02$ 

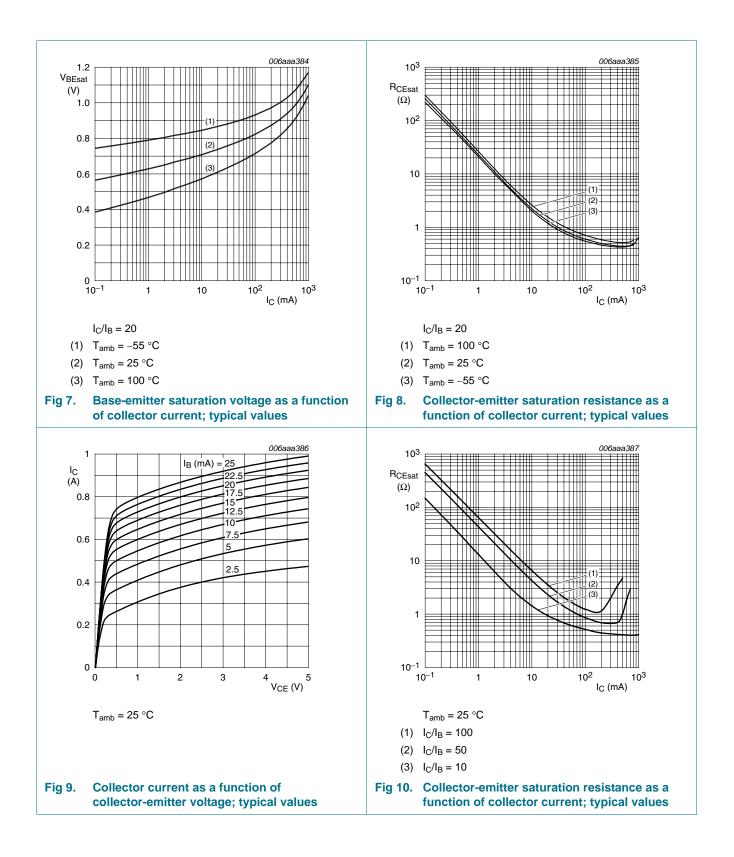
## PBSS2540E

40 V, 500 mA NPN low V<sub>CEsat</sub> (BISS) transistor



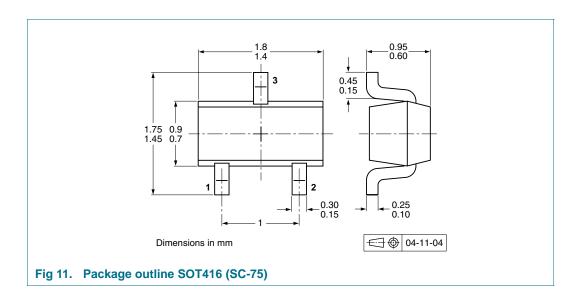
## PBSS2540E

## 40 V, 500 mA NPN low V<sub>CEsat</sub> (BISS) transistor



40 V, 500 mA NPN low V<sub>CEsat</sub> (BISS) transistor

## 8. Package outline



## 9. Packing information

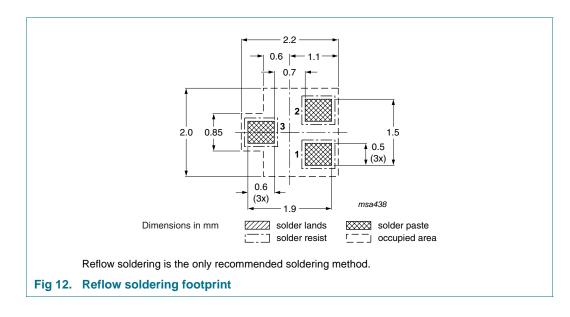
#### Table 8.Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity	
			3000	10000
PBSS2540E	SOT416	4 mm pitch, 8 mm tape and reel	-115	-135

[1] For further information and the availability of packing methods, see Section 13.

## **10. Soldering**



40 V, 500 mA NPN low V<sub>CEsat</sub> (BISS) transistor

## **11. Revision history**

Table 9. Revision h	istory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PBSS2540E_2	20091115	Product data sheet	-	PBSS2540E_1
Modifications:	including nev content.	eet was changed to reflect w legal definitions and disc llector-emitter saturation vo	aimers. No changes w	ere made to the technical
	values": V <sub>CE</sub> • Figure 6 "Co	<sub>sat</sub> unit amended from mV t llector-emitter saturation vo	o V Itage as a function of o	
	02	<sub>sat</sub> unit amended from mV t <u>eflow soldering footprint"</u> : ι		
PBSS2540E_1	20050504	Product data sheet	-	-

40 V, 500 mA NPN low V<sub>CEsat</sub> (BISS) transistor

## 12. Legal information

#### 12.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

The term 'short data sheet' is explained in section "Definitions". [2]

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://w

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PBSS2540E 2

## PBSS2540E

40 V, 500 mA NPN low V<sub>CEsat</sub> (BISS) transistor

## 14. Contents

1	Product profile 1
1.1	General description 1
1.2	Features
1.3	Applications 1
1.4	Quick reference data 1
2	Pinning information 2
3	Ordering information 2
4	Marking 2
5	Limiting values 3
6	Thermal characteristics 4
7	Characteristics 5
8	Package outline 8
9	Packing information 8
10	Soldering 8
11	Revision history 9
12	Legal information 10
12.1	Data sheet status 10
12.2	Definitions 10
12.3	Disclaimers
12.4	Trademarks 10
13	Contact information 10
14	Contents 11

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